## TOSHIBA DIODE SILICON EPITAXIAL PLANAR TYPE

# 1 S V 3 2 4

TCXO / VCO

Unit in mm

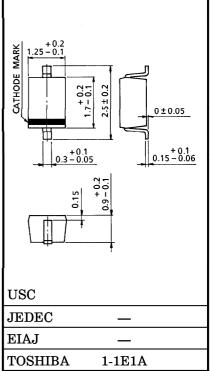
High Capacitance Ratio :  $C_{1V}/C_{4V} = 4.3$  (Typ.)

:  $r_{\rm S} = 0.4 \, \Omega \, ({\rm Typ.})$ Low Series Resistance

Useful for Small Size Tuner.

### MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Reverse Voltage	$v_{ m R}$	10	V
Junction Temperature	$T_{j}$	125	$^{\circ}\mathrm{C}$
Storage Temperature Range	$\mathrm{T_{stg}}$	-55~125	°C



#### ELECTRICAL CHARACTERISTICS (Ta = 25°C)

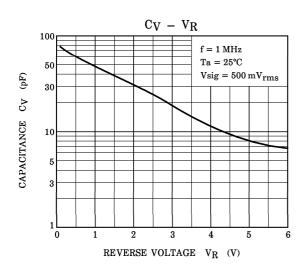
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Reverse Voltage	$v_{ m R}$	$I_R = 1 \mu A$	10	_	_	V
Reverse Current	$I_{ m R}$	$V_R = 10 V$	_	_	3	nA
Capacitance	$c_{1V}$	$V_R = 1 V, f = 1 MHz$	44	_	49.5	pF
Capacitance	$\mathrm{c_{4V}}$	$V_R = 4 V, f = 1 MHz$	9.2	_	12	pF
Capacitance Ratio	$C_{1V}/C_{4V}$	_	4	4.3	_	_
Series Resistance	$r_{\mathrm{S}}$	$V_{ m R}=4 m V,~f=100 m MHz$		0.4	0.8	Ω

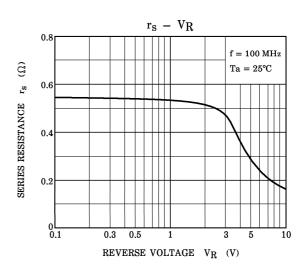
Signal level when capacitance is measured:  $Vsig = 500 \, mV_{rms}$ 

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### SPICE PARAMETER

SPICE MODEL : BERKLEY SPICE.2G.6 DIODE MODEL

DATA FORMAT : MODEL FORMAT

 $SPICE \ SYMBOL \qquad : I_{S}(A), \ R_{S}(\Omega), \ N(-), \ CJ0(F), \ V_{J}(V), \ M(-), \ B_{V}(V), \ I_{BV}(A)$ 

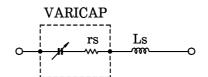
FREQUENCY RANGE :  $f = 0.1 \sim 3 \text{ GHz}$ 

REVERSE VOLTAGE RANGE :  $V_R = 1 \sim 4 \text{ V}$ 

## **PARAMETER**

$$\begin{array}{rcl} I_{S} & = & 2.593E - 15 \\ N & = & 1.024 \\ B_{V} & = & 10 \\ I_{BV} & = & 1.00E - 04 \\ R_{S} & = & 0.4 \\ CJ0 & = & 7.672E - 11 \\ V_{J} & = & 100 \\ M & = & 49.19 \\ - & - & - & - & - \end{array}$$

= 1.00E - 09



(Note 1): These parameters from IS to M mean die characteristic.

Actually device has lead inductance so Ls is necessary for simulation.

And please use default value except above parameters.

(Note 2):  $R_S$  shows the value at the condition of  $V_R=4\,V$  and  $f=100\,MHz$ . If another value is needed, please refer to  $R_S-V_R$  curve in this data sheets.